APPLICA	BLE STAN	DARD						-			
	OPERATING TEMPERATURE RANG		GE -35°C TO +85°C (NOTE 1) STOR. TEMP			RATURE RANGE			-10°C TO +60°C (NOTE 3)		
RATING	OPERATING HUMIDITY RAN	IGE	20% TO 80% (NOTE 2	21	STORAGE HUMIDITY	' RANG	RANGE		40% TO 70% (NOTE 3)		
	APPLICABLE CONNECTOR		DF57H-6S-1.2C(##) DF57AH-6S-1.2C(##)	DF57AH-6S-1.2C(##) C-L		TEMP	RANGE VOLTAGE 29V AC/DC CURRENT AWG 26 TO 28 : 1.5A/		-35°C TO +75°C (NOTE		
	APPLICABLE CONTACT		DF57-****SCF(##)		RATING						
	VOLTAGE		50V AC/DC			CURR			AWG 26 TO 28 : 1.5A/PIN		
	CURRENT		AWG 26 TO 28 : 1.5A/PIN AWG 30 : 1.0A/PIN AWG 32 : 0.8A/PIN AWG 34 : 0.5A/PIN						AWG 30 TO 34 : 1.0A/PIN		
			SPECI	IFICA	TION	S					
IT	EM		TEST METHOD				RE	QUI	REMENTS	QT	AT
CONSTR											
GENERAL EX	AMINATION	VISUALLY	AND BY MEASURING INSTRU	MENT.	AC	CORDI	NG TO D	RAW	ING.	Х	Х
MARKING		CONFIRMED VISUALLY.				X					
	IC CHARA									X	1
CONTACT RESISTANCE MILLIVOLT LEVEL METHOD		20mV MAX, 1mA (DC or 1000 Hz).				10 m <u>Ω</u> MAX.					—
INSULATION RESISTANCE		100V DC.				100 M $_{\Omega}$ MIN.				Х	-
VOLTAGE PROOF		500V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.					
-	ICAL CHA	RACTE	RISTICS								
MECHANICAL OPERATION		30 TIMES INSERTION AND EXTRACTION.				1) CONTACT RESISTANCE: 20 mΩ MAX. 2) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					-
INSERTION AND		IT TAKES OUT AND INSERTS WITH A CONFORMITY				INSERT	ION FOF	RCE	: 30.0 N MAX.	Х	-
EXTRACTION FORCES		CONNECTOR.				2) EXTRACTION FORCE: 1.2 N MIN. 1) NO ELECTRICAL DISCONTINUITY OF 1 μ s. Χ					
		0.75 mm, AT 10 CYCLES FOR 3 DIRECTION.				2) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					_
SHOCK						1) NO ELECTRICAL DISCONTINUITY OF 1 μ s. 2) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					-
ENVIRO	MENTAL		ACTERISTICS			-	- , -	-		1	
DAMP HEAT (STEADY STATE)		(AFTER LEAVING THE ROOM TEMPERATURE FOR 1 TO 2 h.)				1) CONTACT RESISTANCE : 20 m_{Ω} MAX. 2) INSULATION RESISTANCE: 100 M_{Ω} MIN. 3) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	-
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 °C→ +85 °CTIME30 min→ 30 minUNDER 5 CYCLES.(THE TRANSFERRING TIME OF THE TANK IS 2 TO 3 min)				1) CONTACT RESISTANCE : 20 m_{Ω} MAX. 2) INSULATION RESISTANCE: 100 M_{Ω} MIN. 3) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					-
RESISTANCE TO SOLDERING HEAT		«REFLOW TIME»				NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.					_
SOLDERABILITY		SOLDERING TEMPERATURE: 245 °C DURATION OF IMMERSION: SOLDERING, FOR 5 sec.			c. CC	NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE					-
NOTE 2: NO	CLUDE THE TE	EMPERAT G.	URE RISING BY CURRENT DUCT ON PACKAGED CON	Г.		ing im	MERSED	<u>.</u>		<u> </u>	<u> </u>
COUN	T DE	SCRIPTIC	CRIPTION OF REVISIONS DES		DESIGNE	GNED			CHECKED		ΛTE
\land											
									SJ. OKAMURA	2021082	
						CHECKED			SZ. ONO	20210823	
Unless otherwise specified, ref			efer to IEC 60512.			DESIGNED			HK. HAYASHI TS. HONJO	20210823	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				loot	D D D D D D D D D D		N	ELC-343908-23-05			
						NO. DE			ELG-343908-23-05 F57H-6P-1. 2V (23)		
HRS							<u>רו ה</u>			⋒	1/1
FORM HD0011-2-1									0-0100-0-23 Z		1/1